# 2SA0719, 2SA0720 (2SA719, 2SA720)

## Silicon PNP epitaxial planar type

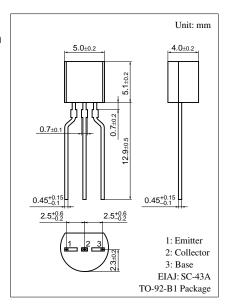
For low-frequency power amplification and driver amplification Complementary to 2SC1317 and 2SC1318

#### ■ Features

• Complementary pair with 2SC1317 and 2SC1318.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Collector to	2SA0719	$V_{CBO}$	-30	V
base voltage	2SA0720		-60	
Collector to	2SA0719	V <sub>CEO</sub>	-25	V
emitter voltage	2SA0720		-50	
Emitter to base voltage		V <sub>EBO</sub>	-5	V
Peak collector current		$I_{CP}$	-1	A
Collector current		$I_{C}$	-500	mA
Collector power dissipation		$P_{\rm C}$	625	mW
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C



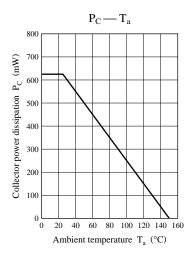
### ■ Electrical Characteristics $T_a = 25$ °C

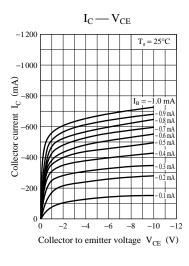
Paramete	r	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff curren	t	I <sub>CBO</sub>	$V_{CB} = -20 \text{ V}, I_E = 0$			- 0.1	μΑ
Collector to base	2SA0719	V <sub>CBO</sub>	$I_C = -10 \mu\text{A},  I_E = 0$	-30			V
voltage	2SA0720			-60			
Collector to emitter	2SA0719	V <sub>CEO</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-25			V
voltage	2SA0720			-50			
Emitter to base voltage		V <sub>EBO</sub>	$I_E = -10 \ \mu A, I_C = 0$	-5			V
Forward current transfer ratio		h <sub>FE1</sub> *	$V_{CE} = -10 \text{ V}, I_{C} = -150 \text{ mA}$	85		340	
		h <sub>FE2</sub>	$V_{CE} = -10 \text{ V}, I_{C} = -500 \text{ mA}$	40			
Collector to emitter saturation voltage		V <sub>CE(sat)</sub>	$I_{\rm C} = -300 \text{ mA}, I_{\rm B} = -30 \text{ mA}$		- 0.35	- 0.6	V
Base to emitter saturation voltage		V <sub>BE(sat)</sub>	$I_C = -300 \text{ mA}, I_B = -30 \text{ mA}$		-1.1	-1.5	V
Transition frequency		$f_T$	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance		C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6	15	pF

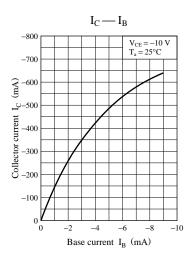
Note) \*: hFE1 Rank classification

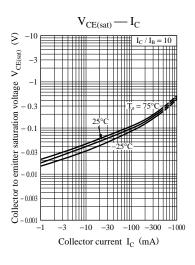
Rank	Q	R	S	
$h_{FE1}$	85 to 170	120 to 240	170 to 340	

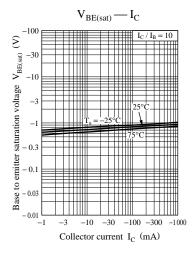
Note) The part numbers in the parenthesis show conventional part number.

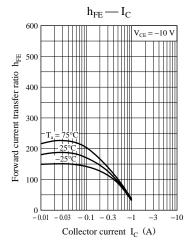


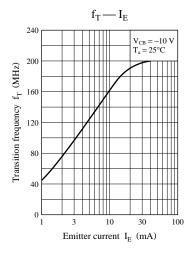


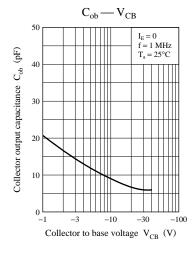


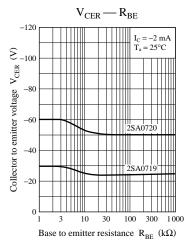


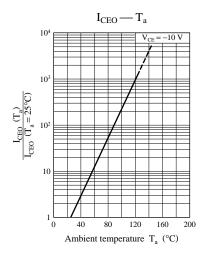


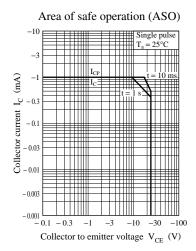












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